

Attorney Docket No. 6661-000024/US/COB Application No. 10/621,380/

E UNITED STATES PATENT AND TRADEMARK OFFICE

Inventors:

Yi Yeol LYU et al.

Conf. No. 4059

Application No.:

10/621,380

Group Art Unit: 1712

Filing Date:

July 18, 2003

Examiner: Margaret G. Moore

Title:

SILOXANE-BASED RESIN AND METHOD FOR FORMING

INSULATING

FILM BETWEEN INTERCONNECT LAYERS IN

SEMICONDUCTOR

DEVICES BY USING THE SAME

REVOCATION AND SUBSTITUTION OF POWER OF ATTORNEY AND CHANGE OF ADDRESS

Customer Service Window Randolph Building 401 Dulany Street Alexandria, VA 22314 April 28, 2006

Sir:

POWER OF ATTORNEY

The Declaration submitted along with this application includes a Power of Attorney listing the attorneys of Birch, Stewart, Kolasch & Birch, LLP. If not already revoked or withdrawn, please hereby revoke the aforementioned attorneys and substitute the attorneys of Customer No. 30593, including the following attorneys of Harness, Dickey & Pierce, P.L.C., to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

John A. Castellano

Registration No. 35,094

Gary D. Yacura

Registration No. 35,416

Terry L. Clark

Registration No. 32,644

Donald J. Daley

Registration No. 34,313

CORRESPONDENCE ADDRESS

I request the Patent and Trademark Office to direct all correspondence and telephone calls relative to this application to Customer No. 30593, Harness, Dickey & Pierce, P.L.C., P.O. Box 8910, Reston, Virginia 20195, (703) 668-8000.

The undersigned is empowered with full Power of Attorney on behalf of the assignee, Samsung Electronics, Inc., by virtue of and as evidenced by an Assignment recorded in connection with parent application No. 10/105,723 (now U.S. Patent 6,623,711) at the United States Patent and Trademark Office at Reel 12998, Frame(s) 954. A copy of the recorded Assignment is enclosed for the convenience of the Office.

Respectfully submitted,

HARNESS, PACKEY & PIERCE, P.L.C.

By:

John A. Castellano, Reg. No. 35,094

P.O. Box 8910

Reston, Virginia 20195

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JAC:pw

Enclosure:

Recorded Assignment





AUGUST 20, 2002

BIRCH, STEWART, KOLASCH & BIRCH, LLP JOSEPH A. KOLASCH P.O. BOX 747 FALLS CHURCH, VA 22040-0747 Under Secretary of Commerce For Intellectual Property and Director of the United States Patent and Trademark Office Washington, DC 20231 www.uspto.gov



102130489A

UNITED STATES PATENT AND TRADEMARK OFFICE NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT DIVISION OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE MICROFILM COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE EMPLOYEE WHOSE NAME APPEARS ON THIS NOTICE AT 703-308-9723. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, ASSIGNMENT DIVISION, BOX ASSIGNMENTS, CG-4, 1213 JEFFERSON DAVIS HWY, SUITE 320, WASHINGTON, D.C. 20231.

RECORDATION DATE: 06/17/2002

REEL/FRAME: 012998/0954

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BRIEF: ASSIGNMENT OF ASSIGNOR'S INTEREST (SEE DOCUMENT FOR DETAILS).

ASSIGNOR:

LYU, YI YEOL DOC DATE: 05/07/2002

ASSIGNOR:

YIM, JIN BEONG DOC DATE: 05/07/2002

ASSIGNOR:

MAH, SANG KOOK DOC DATE: 05/07/2002

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NAH, EUN JU DOC DATE: 05/07/2002

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HWANG II, SUN DOC DATE: 05/07/2002

ASSIGNOR:

JEONG, HYUN DAM DOC DATE: 05/07/2002

ASSIGNOR:

KIM, JUNG HYUNG DOC DATE: 05/07/2002

012998/0954 PAGE 2

ASSIGNEE:

SAMSUNG ELECTRONICS CO., LTD.
MAETAN-3 DONG 416, PALDAL-GU,
SUWON-SHI
KYUNGKI-DO, REPUBLIC OF KOREA

442-742

SERIAL NUMBER: 10105723

PATENT NUMBER:

FILING DATE: 03/27/2002

ISSUE DATE:

MARCUS KIRK, EXAMINER ASSIGNMENT DIVISION OFFICE OF PUBLIC RECORDS



Atty. Docket No.: 3811-109P

Page 1 of 2

102130489 SHEET		
To the Honorable Commissioner of Patents and Trademarks: Please record the Eattached original documents or copy thereof.		
1. Name of conveying party(ies):	2. Name and address of receiving party(ies)	
[FAMILY NAME (ALL CAPS), Given Name]	Name: SAMSUNG ELECTRONICS CO., LTD.	
1. Name of conveying party(ies): [FAMILY NAME (ALL CAPS), Given Name] LYU, Yi Yeol YIM, Jin Beong MAH, Song Kook	Internal Address:	
YIM, Jin Beong	Street Address: Maetan-3 Dong 416, Paldal-Gu, Suwon-	
MAH, Sang Kook	Shi	
NAH, Eun Ju	City: Kyungki-Do State: ZIP:	
Additional name(s) of conveying party(ies) attached? XES NO	Country: Korea Postal Code: 442-742 Additional name(s) & address(es) attached? YES NO	
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Other:		
Execution Date: May 7, 2002		
4. Application number(s) or patent number(s):	·	
If this document is being filed together with a new application, the execution date of the application is:		
A. Patent Application No(s).	B. Patent No.(s).	
10/105,723		
Additional numbers attac		
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total No. of applications/patents involved: One (1)	
Name: BIRCH, STEWART, KOLASCH & BIRCH, LLP	7. Total fee (37 C.F.R. § 3.41): \$40.00	
Street Address: P.O. BOX 747	⊠ Enclosed	
City: FALLS CHURCH State: VA ZIP: 22040-0747	Authorized to be charged to deposit account,	
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DO NOT USE 9. Statement and signature. To the best of my knowledge and belief, the foregoing in	8. Deposit account number: 02-2448 (Attach triplicate copy of this page if paying by deposit account) E THIS SPACE	

06/20/2002 DIAZ1 00000078 10105723 01 FC:581 40.00 OP JAK/mks (Rev. 02/11/02)

Atty. Docket No.: 3811-109P

Page 2 of 2

Attachment to RECORDATION FORM COVER SHEET

RECORDATION FORM COVER SHEET	
Continuation of Box 1Name of conveying party(ies): [FAMILY NAME (ALL CAPS), Family Name] HWANG, Il Sun	
JEONG, Hyun Dam	
KIM, Jung Hyung	
,	
,	
Continuation of Box 2Name and address of receiving party(ies):	
Continuation of Box 4Application number(s) or patent number(s):	

ATTORNEY DOCKET NO. 3811-109 P

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

	Application No. 10/105,723 Filed March 27, 200	
lasert Name(s) of Inventor(s)	WUEDEAC W: W 1 First - 1	
	WHEREAS, Yi Yeol LYU, Jin Heong YIM	
	Sang Kook MAH, Eun Ju NAH	
•	Il Sun HWANG, Hyun Dam JEONG	
	Jung Hyung KIM	
insert Title of Invention	(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in "SILOXANE-BASED RESIN AND METHOD FOR FORMING INSULATING FILM LETWEEN INTERCONNECT LAYERS IN SEMICONDUCTOR DEVICES BY USING THE SAME"	
	for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).	
nsert Date of Signing of Application	on	
nsert Name of Assignee	WHEREAS, SAMSUNG ELECTRONICS CO., LTD.	
nsert Address I Assignee	of Maetan-3 Dong 416, Paldal-Gu, Suwon-Shi, Kyungki-Do 442-742, Republic of Korea	
CHECK BOX	its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and in any foreign countries.	
	NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;	
	and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or	

Attorney Docket No.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United Sintes of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date202.05.09	Name of Inventor (signature) Yi Yeol LYU
Dute 2002 of 07	Name of Inventor
Date 2002. 05. 07	(signature) Jih Heong YIM Name of Inventor (signature) Sang Kook MAH
Date 2002.05.07	Name of Inventor (signature) Eun Ju NAH
Date 2002.05.07	Name of Inventor (signature) I1 Sun HWANG
Date	Name of Inventor
Date 2001.05.07	Name of Inventor (signature) Jung Ayyng KIM